

December 11, 2025

EBARA to Exhibit at SEMICON Japan 2025
- Featuring Booth Exhibits and Exhibitor Seminars -



EBARA Corporation (hereinafter "EBARA") will exhibit at SEMICON Japan 2025, to be held at Tokyo Big Sight from December 17 (Wed) to 19 (Fri). EBARA is also proud to support SEMICON Japan 2025 as a Gold Sponsor.

SEMICON Japan is a premier international exhibition covering the electronics manufacturing supply chain—from manufacturing technologies, equipment, and materials in the semiconductor industry to SMART applications such as automotive and IoT devices.

At the main booth, EBARA will showcase semiconductor manufacturing equipment including CMP and plating system for Panel Level Packaging (PLP), along with dry vacuum pumps, gas abatement systems, and other components. In addition, EBARA will present a session at the exhibitor seminar titled "The cutting edge of post-CMP cleaning technology supporting semiconductor miniaturization" to discuss the latest trends in post-CMP cleaning technology. EBARA will also participate in organizer seminars, the "Mirai COLLEGE @ SEMICON" student event, and exhibit panels in the JOINT2 consortium area.

Exhibition Overview

Exhibition Name: SEMICON Japan 2025

Dates: December 17 (Wed) – 19 (Fri), 2025

Hours: 10:00 – 17:00

Looking ahead, going beyond expectations

Ahead > Beyond



Venue: Tokyo Big Sight

Organizer: SEMI

1. Main Booth

Under the themes of miniaturization, advanced packaging, and green sustainability, this booth introduces CMP and plating system for PLP and wafers, component products, and EBARA's sustainability initiatives.

Venue: South Hall, Tokyo Big Sight (Booth No. S2634)

Key Exhibits: CMP and plating system for PLP and wafer, bevel polishing system, dry vacuum pumps, gas abatement systems, chillers, canned motor pumps, and EBARA's sustainability initiatives.

2. Exhibitor Seminar: "EXHIBITOR'S TechSPOT"

This session focuses on post-CMP cleaning technology trends and solutions for Cu dishing.

Date/Time: December 19 (Fri), 10:30 – 10:50

Venue: Open Space, West Hall, Tokyo Big Sight

Fee: Free

3. Organizer Seminar: "ESG – Pathways to a Sustainable Future"

EBARA will present "The Engine for Sustainable Chipmaking," introducing energy-saving technologies and ESG activities.

Date/Time: December 19 (Fri), 13:30 – 15:00 (EBARA presentation: 14:15 – 14:30)

Venue: Room 607-608, Conference Tower, Tokyo Big Sight

Fee: Free

4. Human Resources Events

EBARA will participate in the following HR-related events and programs held within SEMICON Japan:

Mirai COLLEGE @ SEMICON

Includes company briefings at the booth (Booth No. C1025) and booth tours. EBARA employees will also join the panel discussion "Incredible! Colleagues in the Semiconductor Industry".

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Booth Tour: Dec 17–19, 15:30 at the Mirai COLLEGE reception.

Panel Discussion: Dec 18 (Thu), 10:00 – 11:30 at "TechSTAGE ZEN".

"WAKAMONO" CONNECT: A workshop for young industry employees and students to network.

This workshop brings together young industry employees and students in groups for themed talks, including games; EBARA's young employees will participate.

Date/Time: Dec 18 (Thu), 18:30 – 19:30

Venue: TechSTAGE ZEN, 1F Conference Tower

TECH CAMP Hackathon Presentation

This is a three-day intensive program centered on a Hackathon themed "Innovate for the next 10 years," which includes seminars and networking. EBARA employees will participate and present their results.

Date/Time: December 19 (Fri), 13:30 – 17:00

Venue: Room 102, Conference Tower, Tokyo Big Sight (TechSTAGE YUZU)

In addition to participating in these events, EBARA employees will participate in the DE&I Working Group, and EBARA will also sponsor THE KOSEN.

5. JOINT2 Area

EBARA will exhibit posters/panels regarding CMP equipment for large-panel packaging (PLP) within the JOINT2 consortium area.

Venue: East Hall, Tokyo Big Sight (Booth No. E4945)

- About the EBARA Group -

The EBARA Group aims to contribute to the achievement of the Sustainable Development Goals (SDGs) by addressing material issues identified in its long-term vision and executing the medium-term management plan to increase corporate value.